

Qualified Vendors List (QVL) - Memory

Project Name : P6T6 WS REVOKUTION 1.01G BIOS : 0201

Vendor	Part No.	Size	SS/DS
CORSAIR	Box P/N:TWIN3X2048-1600C7DHXIN (CM3X1024-1600C7DHXIN)(XMP)	DDR3 1600 2048MB(Kit of 2)	SS
CORSAIR	BoxP/N:TW3X4G1600C9DHXNV(CM3X 2G1600C9DHXNV)	DDR3 1600 4096MB(Kit of 2)	DS
CORSAIR	BoxP/N:TWIN3X4096-1600C7DHXIN (CM3X2048-1600C7DHXIN)	DDR3 1600 4096MB(Kit of 2)	DS
Crucial	BL12864BA1608.8SFB(XMP)	DDR3 1600 1024MB	SS
G.SKILL	F3-12800CL7D-2GBHZ	DDR3 1600 2048MB(Kit of 2)	SS
G.SKILL	F3-12800CL9D-2GBNQ	DDR3 1600 2048MB(Kit of 2)	SS
G.SKILL	F3-12800CL7D-4GBPI	DDR3 1600 4096MB(Kit of 2)	DS
Kingston	KHX12800D3K2/4G	DDR3 1600 4096MB(Kit of 2)	SS
OCZ	OCZ3T1600XM2GK(XMP)	DDR3 1600 2048MB(Kit of 2)	SS
OCZ	OCZ3P1600EB4GK	DDR3 1600 4096MB(Kit of 2)	DS
OCZ	OCZ3X16004GK	DDR3 1600 4096MB(Kit of 2)	DS
Aeneon	AXH760UD10-16H	DDR3 1600 1024MB	SS
Aeneon	AXH860UD20-16H	DDR3 1600 2048MB	DS
Mushkin	996657	DDR3 1600 4096MB(Kit of 2)	DS
Patriot	PVS34G1600LLKN	DDR3 1600 4096MB(Kit of 2)	DS
PQI	MFADR401PA0102	DDR3 1600 2048MB	DS
Team	BoxP/N:TXD32048M1600HC7DC (TXD31024M1600HC7)	DDR3 1600 2048MB(Kit of 2)	SS

A* : Supports one module inserted in any slot as Single-channel memory configura

B* : Supports one pair of modules inserted into either the blue slots or the black slc

C* : Supports 4 modules inserted into both the blue and black slots as two pairs of

D* : Supports 6 modules inserted into both the blue and black slots as two pairs of

Chip No.	CL	Chip Brand	DIMM socket support (Optional)			
			A*	B*	C*	D*
Heat-Sink Package	7	N/A	V	V	V	V
Heat-Sink Package	9-9-9-24	N/A	V	V	V	V
Heat-Sink Package	N/A	N/A	V	V	V	V
Heat-Sink Package	N/A	PQI	V	V	V	V
Heat-Sink Package	7-7-7-18	N/A	V		V	V
Heat-Sink Package	9-9-9-24	N/A	V	V	V	V
Heat-Sink Package	7-7-7-18	N/A	V	V	V	
Heat-Sink Package	N/A	N/A	V	V	V	
Heat-Sink Package	N/A	N/A		V	V	V
Heat-Sink Package	776	N/A	V	V	V	V
Heat-Sink Package	7-7-7-20	N/A	V		V	V
Heat-Sink Package	9	N/A	V	V	V	V
Heat-Sink Package	9	N/A	V	V	V	V
Heat-Sink Package	7-7-7-20	N/A	V	V	V	V
Heat-Sink Package	7-7-7-20	N/A	V	V	V	
K4B1G08460	9-9-9-24	SAMSUNG	V	V	V	V
Heat-Sink Package	7-7-7-21	N/A	V	V	V	V

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its as one pair of Dual-channel memory configuration

Dual-channel memory configuration

Triple-channel memory configuration